

July 1988 Revised August 2000

100353

Low Power 8-Bit Register

General Description

The 100353 contains eight D-type edge triggered, master/slave flip-flops with individual inputs (D_n) , true outputs (Q_n) , a clock input (CP), and a common clock enable pin $(\overline{\text{CEN}})$. Data enters the master when CP is LOW and transfers to the slave when CP goes HIGH. When the $\overline{\text{CEN}}$ input goes HIGH it overrides all other inputs, disables the clock, and the Q outputs maintain the last state.

The 100353 output drivers are designed to drive 50Ω termination to –2.0V. All inputs have 50 $k\Omega$ pull-down resistors.

Features

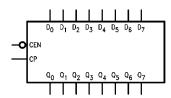
- Low power operation
- 2000V ESD protection
- Voltage compensated operating range = -4.2V to -5.7V
- Available to industrial grade temperature range

Ordering Code:

Order Number	Package Number	Package Description
100353PC	N24E	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
100353QC	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
100353QI		28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (–40°C to +85°C)

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol

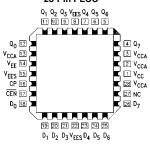


Pin Descriptions

Pin Names	Description
D ₀ –D ₇	Data Inputs
CEN	Clock Enable Input
СР	Clock Input (Active Rising Edge)
Q ₀ –Q ₇	Data Outputs
NC	No Connect

Connection Diagrams



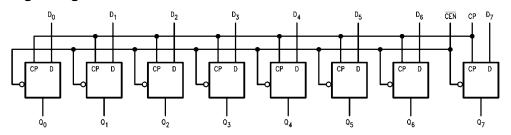


Truth Table

	Inputs	Outputs	
D _n	CEN	СР	Q_n
L	L	~	L
Н	L	~	Н
Х	Х	L	NC
Х	Х	Н	NC
Х	Н	X	NC

- H = HIGH Voltage Level
 L = LOW Voltage Level
 X = Don't Care
 NC = No Change
 \(= LOW LOW

Logic Diagram



Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

Case Temperature (T_C)

 $\begin{array}{ccc} \text{Commercial} & 0^{\circ}\text{C to +85^{\circ}\text{C}} \\ \text{Industrial} & -40^{\circ}\text{C to +85^{\circ}\text{C}} \\ \text{Supply Voltage (V}_{\text{EE}}) & -5.7\text{V to -4.2V} \\ \end{array}$

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

DC Electrical Characteristics (Note 3)

 $\rm V_{EE} = -4.2V$ to $-5.7V,~V_{CC} = V_{CCA} = GND,~T_{C} = 0^{\circ}C$ to $+85^{\circ}C$

Symbol	Parameter	Min	Тур	Max	Units	Cond	ditions		
V _{OH}	Output HIGH Voltage	-1025	-955	-870	mV	V _{IN} = V _{IH} (Max)	Loading with		
V _{OL}	Output LOW Voltage	-1830	-1705	-1620	mV	or V _{IL} (Min)	50Ω to $-2.0V$		
V _{OHC}	Output HIGH Voltage	-1035			mV	V _{IN} = V _{IH} (Min)	Loading with		
V _{OLC}	Output LOW Voltage			-1610	mV	or V _{IL} (Max)	50Ω to $-2.0V$		
V _{IH}	Input HIGH Voltage	-1165		-870	mV	Guaranteed HIGH Signal for all Inputs			
V _{IL}	Input LOW Voltage	-1830		-1475	mV	Guaranteed LOW Signal for all Inputs			
I _{IL}	Input LOW Current	0.50			μΑ	$V_{IN} = V_{IL}$ (Min)			
I _{IH}	Input HIGH Current			240	μΑ	V _{IN} = V _{IH} (Max)			
I _{EE}	Power Supply Current					Inputs OPEN			
		-119		-61	mA	$V_{EE} = -4.2V \text{ to } -4.8V$			
		-122		-61		V _{EE} = -4.2V to -5.7V			

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

DIP AC Electrical Characteristics

 $V_{\mbox{\footnotesize EE}} = -4.2 \mbox{\footnotesize V}$ to $-5.7 \mbox{\footnotesize V}, \mbox{\footnotesize $V_{\mbox{\footnotesize CC}} = V_{\mbox{\footnotesize CCA}} = \mbox{\footnotesize GND}}$

Symbol	Parameter	T _C =	= 0°C	T _C = +25°C		$T_C = +85^{\circ}C$		Units	Conditions
Oyillboi		Min	Max	Min	Max	Min	Max	Ointo	Conditions
f _{MAX}	Toggle Frequency	425		425		425		MHz	Figures 1, 2
t _{PLH} t _{PHL}	Propagation Delay CP to Output	1.40	3.00	1.40	3.00	1.50	3.10	ns	Figures 1, 2 (Note 4)
t _{TLH} t _{THL}	Transition Time 20% to 80%, 80% to 20%	0.45	2.00	0.45	2.00	0.45	2.00	ns	Figures 1, 2
t _S	Setup Time Dn CEN (Disable Time) CEN (Release Time)	1.10 0.40 1.10		1.10 0.40 1.10		1.10 0.40 1.10		ns	Figures 1, 3
t _H	Hold Time D _n	0.10		0.10		0.10		ns	Figures 1, 4
t _{PW} (H)	Pulse Width HIGH CP	2.00		2.00		2.00		ns	Figures 1, 2

Note 4: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

Compleal	Barramet		T _C =	T _C = 0°C		+25°C	T _C = ·	+85°C	Units	T
Symbol	Parameter	er	Min	Max	Min	Max	Min	Max	Units	Conditions
f _{MAX}	Toggle Frequency		425		425		425		MHz	Figures 1, 2
t _{PLH}	Propagation Delay CP to Output		1.40	2.80	1.40	2.80	1.50	2.90	ns	Figures 1, 2 (Note 5)
t _{TLH} t _{THL}	Transition Time 20% to 80%, 80% to 2	20%	0.45	1.90	0.45	1.90	0.45	1.90	ns	Figures 1, 2
t _S	Setup Time Dn CEN (Disable Time) CEN (Release Time)	•	1.00 0.30 1.00		1.00 0.30 1.00		1.00 0.30 1.00		ns	Figures 1, 3
t _H	Hold Time	D _n	0		0		0		ns	Figures 1, 4
t _{PW} (H)	Pulse Width HIGH	CP	2.00		2.00		2.00		ns	Figures 1, 2
toshl	Maximum Skew Comr Output-to-Output Varia Data to Output Path	•		200		200		200	ps	PLCC Only (Note 6)
t _{OSLH}	Maximum Skew Commoutput-to-Output Variation Data to Output Path	Ü		200		200		200	ps	PLCC Only (Note 6)
t _{OST}	Maximum Skew Oppo Output-to-Output Varia Data to Output Path	Ü		260		260		260	ps	PLCC Only (Note 6)
t _{PS}	Maximum Skew Pin (Signal) Transition Data to Output Path	n Variation		280		280		280	ps	PLCC Only (Note 6)

Note 5: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

Note 6: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}) , or LOW-to-HIGH (t_{OSLH}) , or in opposite directions both HL and LH (t_{OST}) . Parameters t_{OST} and t_{PS} guaranteed by design.

Industrial Version

PLCC DC Electrical Characteristics

 $\mbox{V}_{EE} = -4.2\mbox{V}$ to $-5.7\mbox{V}, \mbox{V}_{CC} = \mbox{V}_{CCA} = \mbox{GND}, \mbox{T}_{C} = -40\mbox{°C}$ to $+85\mbox{°C}$ (Note 7)

Symbol	Parameter	T _C = ·	-40°C	$T_C = 0^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions		
Symbol	i arameter	Min	Max	Min	Max	Oilles	Conditi	Olis	
V _{OH}	Output HIGH Voltage	-1085	-870	-1025	-870	mV	V _{IN} = V _{IH} (Max)	Loading with	
V _{OL}	Output LOW Voltage	-1830	-1575	-1830	-1620	mV	or V _{IL} (Min)	50Ω to –2.0V	
V _{OHC}	Output HIGH Voltage	-1095		-1035		mV	V _{IN} = V _{IH} (Min)	Loading with	
V _{OLC}	Output LOW Voltage		-1565		-1610	mV	or V _{IL} (Max)	50Ω to –2.0V	
V _{IH}	Input HIGH Voltage	-1170	-870	-1165	-870	mV	Guaranteed HIGH Signal for all Inputs		
V _{IL}	Input LOW Voltage	-1830	-1480	-1830	-1475	mV	Guaranteed LOW Signal for all Inputs		
I _{IL}	Input LOW Current	0.50		0.50		μΑ	$V_{IN} = V_{IL}$ (Min)		
I _{IH}	Input HIGH Current		240		240	μΑ	V _{IN} = V _{IH} (Max)		
I _{EE}	Power Supply Current						Inputs OPEN		
		-119	-61	-119	-61	mA	$V_{EE} = -4.2V \text{ to } -4.8V$		
		-122	-61	-122	-61		$V_{EE} = -4.2V \text{ to } -5.7V$		

Note 7: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

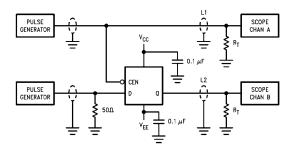
PLCC AC Electrical Characteristics

 $V_{EE} = -4.2V$ to -5.7V, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	T _C =	$T_C = -40^{\circ}C$		T _C = +25°C		$T_C = +85^{\circ}C$		Conditions
		Min	Max	Min	Max	Min	Max	Units	Conditions
f _{MAX}	Toggle Frequency	425		425		425		MHz	Figures 1, 2
t _{PLH} t _{PHL}	Propagation Delay CP to Output	1.40	2.80	1.40	2.80	1.50	2.90	ns	Figures 1, 2 (Note 8)
t _{TLH} t _{THL}	Transition Time 20% to 80%, 80% to 20%	0.40	2.50	0.45	1.90	0.45	1.90	ns	Figures 1, 2
t _S	Setup Time Dn CEN (Disable Time) CEN (Release Time)	0.60 0.90 1.40		1.00 0.30 1.00		1.00 0.30 1.00		ns	Figures 1, 3
t _H	Hold Time D _n	0.30		0		0		ns	Figures 1, 4
t _{PW} (H)	Pulse Width HIGH CP	2.00		2.00		2.00		ns	Figures 1, 2

Note 8: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

Test Circuitry



Note:

- V_{CC}, V_{CCA} = +2V, V_{EE} = -2.5V
- L1 and L2 = equal length 50Ω impedance lines
- $R_T = 50\Omega$ terminator internal to scope
- Decoupling 0.1 μF from GND to V_{CC} and V_{EE}
- All unused outputs are loaded with 50Ω to GND
- $\bullet \quad C_L = \text{Fixture and stray capacitance} \leq 3 \text{ pF}$

FIGURE 1. AC, Toggle Frequency Test Circuit

Switching Waveforms

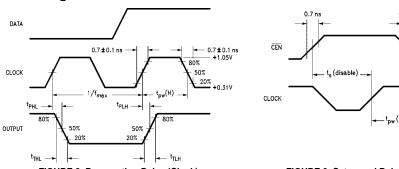
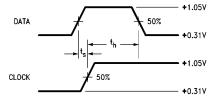


FIGURE 2. Propagation Delay (Clock) and Transition Times

FIGURE 3. Setup and Pulse Width Times

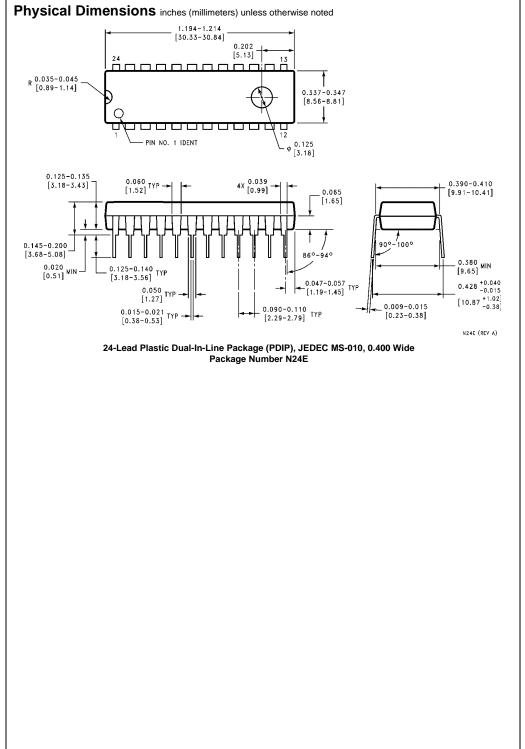
. t_s (release) 🗻



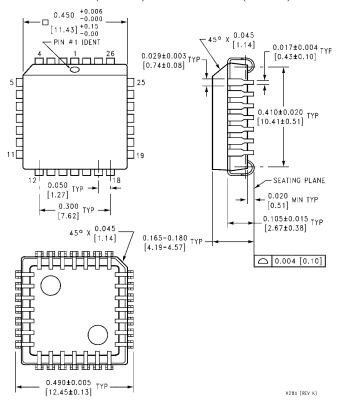
Note

 $t_{\rm S}$ is the minimum time before the transition of the clock that information must be present at the data input. $t_{\rm H}$ is the minimum time after the transition of the clock that information must remain unchanged at the data input.

FIGURE 4. Data Setup and Hold Time



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Package Number V28A

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